MN101C74 Series

Туре	MN101C74F	MN101C74G	MN101CF74G			
Internal ROM type	Mask ROM		FLASH			
ROM (byte)	96K	12	128K			
RAM (byte)	6K					
Package (Lead-free)	LQFP100-P-1414, MLGA100-L-1010, QFP100-P-1818B					
Minimum Instruction Execution Time	0.1 μs (at 3.0 V to 3.6 V, 10 MHz) 0.235 μs (at 1.8 V to 3.6 V, 4.25 MHz)* 62.5 μs (at 1.8 V to 3.6 V, 32 kHz)* *: The lower limit for operation guarantee for flash memory built-in type is 2.2 V.					

■ Interrupts

RESET. Watchdog. External 0 to 5. External 6 (key interrupt dedicated). Timer 0 to 3. Timer 6. Timer 7 (2 systems). Timer 8 (2 systems). Time base. Serial 0 (2 systems). Serial 1 (2 systems). Serial 3. Serial 4. A/D conversion finish. Automatic transfer finish

■ Timer Counter

8-bit timer \times 5

Timer 1Square-wave output. Event count. Synchronous output event

Timer 3Square-wave output. Event count. Serial transfer clock output

Timer 68-bit freerun timer

Timer 0, 1 can be cascade-connected

Timer 2, 3 can be cascade-connected

16-bit timer \times 2

Timer 7, 8 can be cascade-connected: Square-wave output, PWM is possible as a 32-bit timer

Time base timer: One-minute count setting

Watchdog timer × 1

■ Serial interface

Synchronous type/UART (full-duplex) × 2: Serial 0, 1

Synchronous type/Single-master $I^2C \times 1$: Serial 3

 I^2C slave \times 1: Serial 4

Serial 4......I²C high-speed transfer mode. 7-bit/10-bit address setting. General call

■ DMA controller

Maximum transfer cycles: 255

Starting factor: External request. Various types of interrupt. Software

Transfer mode: 1-byte transfer. Word transfer. Burst transfer

■ I/O Pins

I/O 87: Common use. Specified pull-up resistor available. Input/output selectable (bit unit)

■ A/D converter

10-bit × 16 channels (with S/H)

■ Display control function

LCD: 47 segments × 4 commons (Static, 1/2, 1/3, or 1/4 duty)

LCD power supply separated from VDD (usable if VDD \leq VLCD \leq 3.6 V)

LCD power step-up circuit contained (3/2 times, 2 times and 3 times)

LCD power shunt resistance contained

Special Ports

Buzzer output. Inverted buzzer output. Remote control carrier output. High-current drive port

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■ ROM Correction

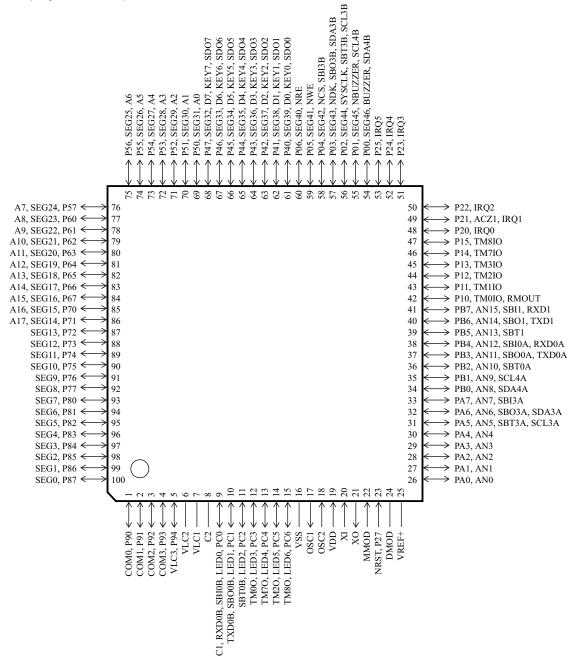
Correcting address designation: Up to 7 addresses possible

■ Electrical Charactreistics (Supply current)

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	Ullit
Operating supply current	IDD1	fosc = 4 MHz. VDD = 3 V		1.1	1.9	mA
	IDD2	fx = 32 kHz. VDD = 3 V		6	20	μΑ
Supply current at HALT	IDD3	$fx = 32 \text{ kHz. VDD} = 3 \text{ V. Ta} = 25 ^{\circ}\text{C}$		3	6	μΑ
	IDD4	$fx = 32 \text{ kHz. VDD} = 3 \text{ V. Ta} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$			13	μΑ
Supply current at STOP	IDD5	VDD = 3 V. Ta = 25 °C			2	μA
	IDD6	$VDD = 3 \text{ V. } Ta = -40 ^{\circ}\text{C to } +85 ^{\circ}\text{C}$			10	μA

■ Pin Assignment

QFP100-P-1818B, LQFP100-P-1414, MLGA100-L-1010



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